

1.6X0.8mm INFRARED EMITTING DIODE

Part Number: KP-1608F3C

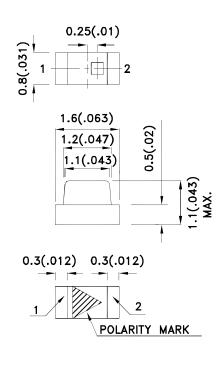
Features

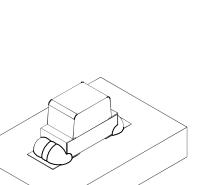
- 1.6mmX0.8mm SMT LED, 1.1mm thickness.
- Mechanically and spectrally matched to the phototran-
- Package: 2000pcs / reel.
- Moisture sensitivity level : level 3.
- RoHS compliant.

Description

F3 Made with Gallium Arsenide Infrared Emitting diodes.

Package Dimensions







- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is $\pm 0.1(0.004")$ unless otherwise noted.
- 3.The specifications, characteristics and technical data described in the datasheet are subject to change without prior notice.
 4.The device has a single mounting surface. The device must be mounted according to the specifications.



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Selection Guide

| Part No. | Dice | Lens Type | Po (mW/sr) [2] @ 20mA | | Viewing Angle [1] |
|------------|-----------|-------------|--------------------------|------|----------------------|
| | | - | Min. | Тур. | 201/2 |
| KP-1608F3C | F3 (GaAs) | Water Clear | 1.2 | 3 | 120° |
| | | | *0.8 | *2 | |

- $1. \, \theta 1/2$ is the angle from optical centerline where the luminous intensity is 1/2 of the optical peak value.
- Radiant Intensity/ luminous flux: +/-15%.
 Radiant intensity value is traceable to the CIE127-2007 compliant national standards.

Electrical / Optical Characteristics at TA=25°C

| Parameter | P/N | Symbol | Тур. | Max. | Units | Test Conditions |
|--------------------------|-----|--------|------|------|-------|-----------------|
| Forward Voltage [1] | F3 | VF | 1.2 | 1.6 | V | IF=20mA |
| Reverse Current | F3 | lr | | 10 | uA | VR = 5V |
| Capacitance | F3 | С | 90 | | pF | VF=0V;f=1MHz |
| Peak Spectral Wavelength | F3 | λP | 940 | | nm | IF=20mA |
| Spectral Bandwidth | F3 | Δλ1/2 | 50 | | nm | IF=20mA |

1. Forward Voltage: +/-0.1V.

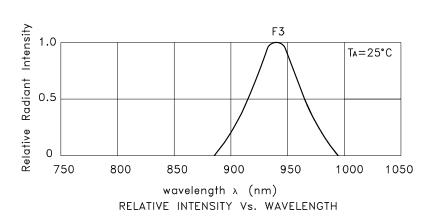
2. Wavelength value is traceable to the CIE127-2007 compliant national standards.

Absolute Maximum Ratings at TA=25°C

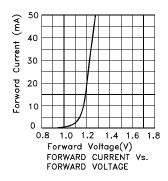
| Parameter | Symbol | F3 | Units | | | | |
|--------------------------|--------|------------|-------|--|--|--|--|
| Power dissipation | PD | 80 | mW | | | | |
| DC Forward Current | lF | 50 | mA | | | | |
| Peak Forward Current [1] | iFS | 1.2 | А | | | | |
| Reverse Voltage | VR | 5 | V | | | | |
| Operating Temperature | Та | -40 To +85 | °C | | | | |
| Storage Temperature | Тѕтс | -40 To +85 | °C | | | | |

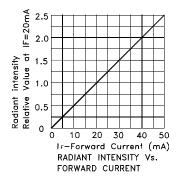
Note: 1. 1/100 Duty Cycle, 10µs Pulse Width.

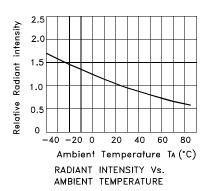
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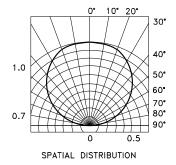


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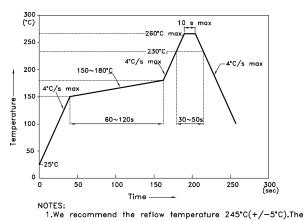
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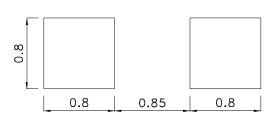
Reflow soldering is recommended and the soldering profile is shown below. Other soldering methods are not recommended as they might cause damage to the product.

Reflow Soldering Profile For Lead-free SMT Process.

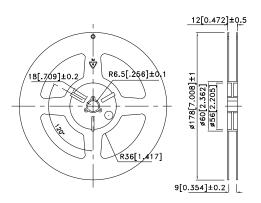


- 1.We recommend the reflow temperature 245°C(+/-5°C).The maximum soldering temperature should be limited to 260°C.
 2.Don't cause stress to the epoxy resin while it is exposed to high temperature.
- 3. Number of reflow process shall be 2 times or less.

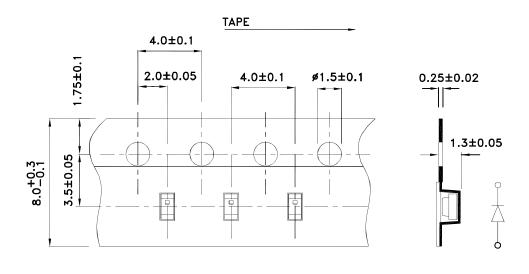
Recommended Soldering Pattern (Units: mm; Tolerance: ± 0.1)



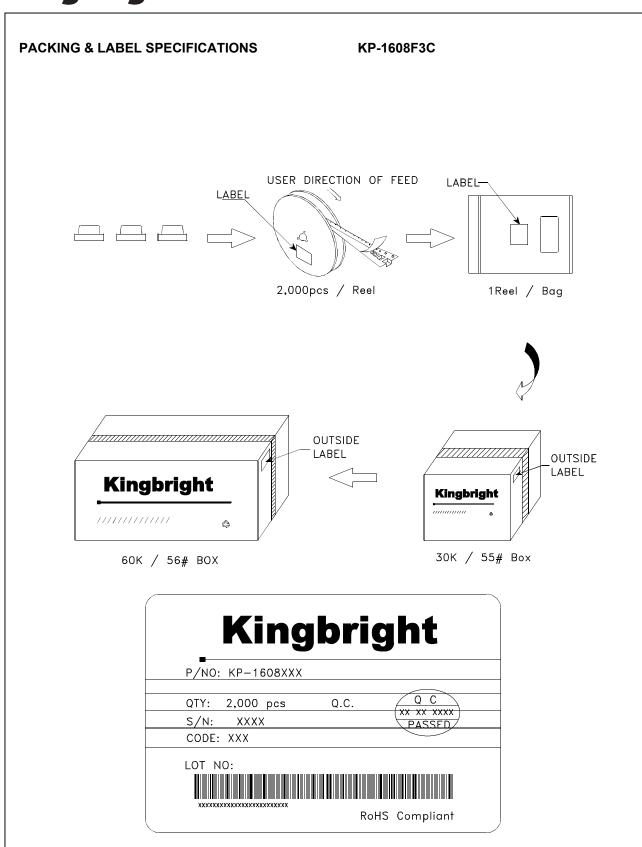
Reel Dimension



Tape Specifications (Units: mm)



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